$T-1^3/_4$ (5 mm), T-1 (3 mm) **Blue LED Lamps**

Technical Data

Description

These blue LEDs are designed in industry standard T-1 and T-13/4 package with clear and non diffused optics. They are also available in tape and reel, and ammo-pack option for ease of handling and use.

These blue lamps are ideal for use as indicators and for general purpose lighting. Blue lamps offer color differentiation as blue is attractive and not widely available.

HLMP-KB45-A00xx

HLMP-DB25-B00xx

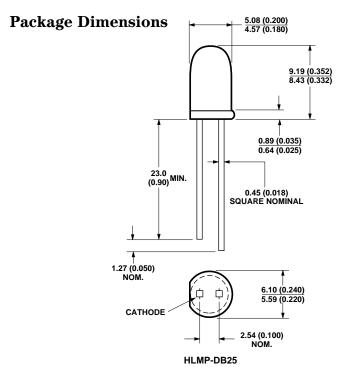


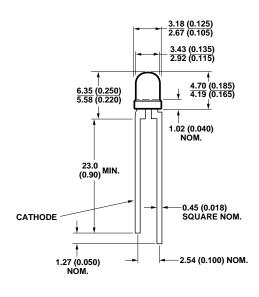
Features

- Popular $T-1^3/_4$ and T-1**Diameter Packages**
- General Purpose Leads
- · Reliable and Rugged
- Available on Tape and Reel
- Binned for Color and Intensity

Applications

- Status Indicators
- Small Message Panel
- Running and Decorative **Lights for Commercial Use**





HLMP-KB45

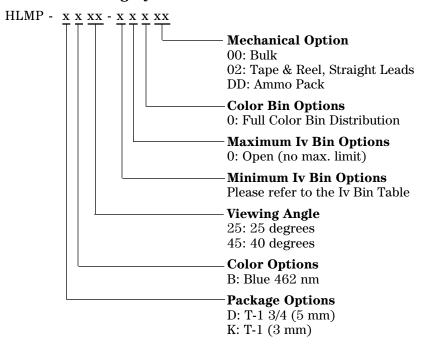
- 1. ALL DIMENSIONS ARE IN MILLIMETERS (INCHES).
 2. EPOXY MENISCUS MAY EXTEND ABOUT 1 mm (0.040") DOWN THE LEADS.

CAUTION: Devices are Class II ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

Selection Guide

			Luminous Intensity Iv (mcd)	
Part Number	Package	Viewing Angle	Min.	Max.
HLMP-KB45-A00xx	T-1	40	30	_
HLMP-DB25-B00xx	T-1 3/4	25	40	_

Part Numbering System



Absolute Maximum Ratings at $T_A = 25$ °C

Parameter	Blue	Units
Peak Forward Current	70	mA
DC Current ^[1]	30	mA
Reverse Voltage ($I_R = 100 \mu A$)	5	V
Transient Forward Current ^[2] (10 µsec Pulse)	350	mA
LED Junction Temperature	115	°C
Operating Temperature	-20 to +80	°C
Storage Temperature	-30 to +100	°C
Lead Soldering Temperature [1.6 mm (0.063 in.) from body]	260℃ for 5 s	seconds

Notes:

- 1. Derate linearly from 50 $^{\circ}\mathrm{C}$ as shown in Figure 6.
- 2. The transient peak current is the maximum non-recurring peak current that can be applied to the device without damaging the LED die and wirebond. It is not recommended that this device be operated at peak currents above the Absolute Maximum Peak Forward Current.

Optical Characteristics at $T_A = 25$ °C

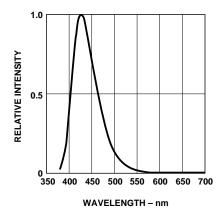
	Luminous Intensity Iv (mcd) @ I _F = 20 mA		Color, Dominant Wavelength $\lambda_d^{[1]}$ (nm)	Peak Wavelength λ _{PEAK} (nm)	$egin{array}{c} ext{Viewing} & & & & & & & & & & & & & & & & & & &$
Part Number	Min.	Typ.	Typ.	Тур.	Typ.
HLMP-DB25-B00xx	40	100	462	426	25
HLMP-KB45-A00xx	30	45	462	426	40

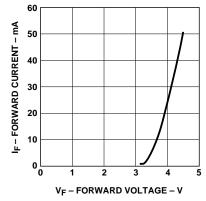
Notes:

- 1. The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half of the axial luminous intensity.

Electrical Characteristics at $T_A = 25$ °C

Part	Volt V _F (V	ward tage Volts) 20 mA	Revo Break V _R (V @ I _R =	down (olts)	$\begin{array}{c} \textbf{Speed} \\ \textbf{Response} \\ \textbf{\tau}_{s} \ (\textbf{ns}) \end{array}$	$\label{eq:capacitance} \begin{split} & Capacitance \\ & C\;(pF),V_F=0, \\ & f=1\;MHz \end{split}$	Thermal Resistance Rθ _{J-PIN} (°C/W) Junction to Cathode Lead
Number	Тур.	Max.	Min.	Тур.	Тур.	Typ.	Typ.
HLMP-DB25-B00xx	4.0	5.0	5.0	30	500	97	260
HLMP-KB45-A00xx	4.0	5.0	5.0	30	500	97	290





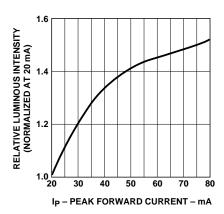
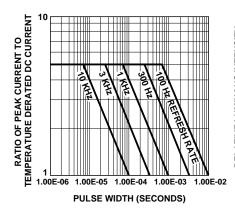
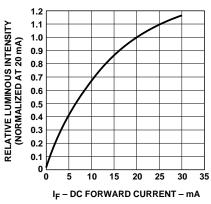


Figure 1. Relative Intensity vs. Wavelength.

Figure 2. Forward Current vs. Forward Voltage.

Figure 3. Relative Intensity vs. Peak Forward Current (300 μs pulse width, 10 ms period).





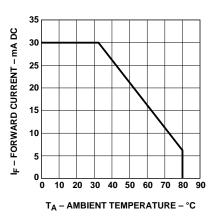


Figure 4. Forward Current vs. Forward Voltage.

Figure 5. Relative Luminous Intensity vs. Forward Current.

Figure 6. Maximum DC Forward Current vs. Ambient Temperature. Derating Based on T_J Max. = 115 $^{\circ}$ C.

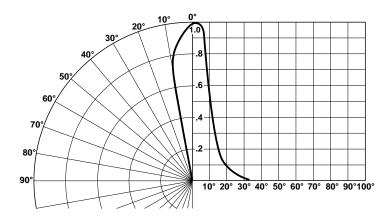


Figure 7. Relative Luminous Intensity vs. Angular Displacement for HLMP-DB25.

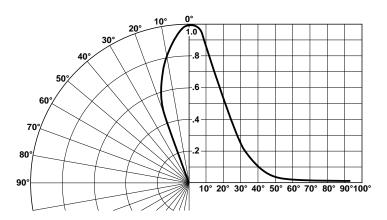


Figure 8. Relative Luminous Intensity vs. Angular Displacement for HLMP-KB45.

Soldering/Cleaning

Cleaning agents from the ketone family (acetone, methyl ethyl ketone, etc.) and from the chlorinated hydrocarbon family (methylene chloride, trichloroethylene, carbon tetrachloride, etc.) are not recommended for cleaning LED parts. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

For information on soldering LEDs, please refer to Application Note 1027.

Intensity Bin Limits

	Intensity Range (mcd)		
Bin	Min.	Max.	
A	30.0	40.0	
В	40.0	50.0	
С	50.0	65.0	
D	65.0	85.0	
E	85.0	110.0	
F	110.0	140.0	
G	140.0	180.0	
Н	180.0	240.0	
J	240.0	310.0	
K	310.0	400.0	
L	400.0	520.0	
M	520.0	680.0	
N	680.0	880.0	

Color Bin Limits (nm at 20 mA)

Blue	nm @ 20 mA			
Bin ID	Min.	Max.		
1	460.0	464.0		
2	464.0	468.0		
3	468.0	472.0		
4	472.0	476.0		
5	476.0	480.0		

Tolerance for each bin limit will be \pm 0.5nm.

Mechanical Option Matrix

Mechanical Option Code	Definition	
00	Bulk Packaging, minimum increment 500 pcs/bag	
02	Tape & Reel, straight leads, minimum increment 1300 pcs/bag	
DD	Ammo Pack, straight leads with minimum increment	

Note

All categories are established for classification of products. Products may not be available in all categories. Please contact your local Agilent representative for further clarification/information.



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Data subject to change.

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